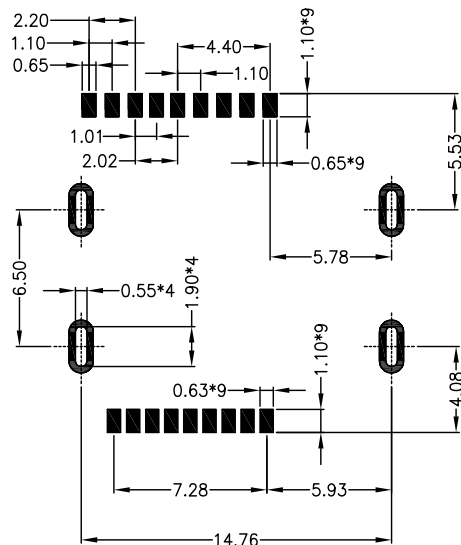
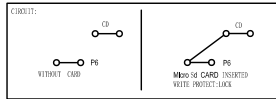


此处禁部机购



RECOMMEND PCB LAYOUT: ■ PCB AREA 焊接区  
(Unit:mm .X ± 0.15 .XX ± 0.05 .XXX ± 0.02)

| PIN NO. | PIN ASSIGNMENT                        |
|---------|---------------------------------------|
| 1#      | DAT2 信号                               |
| 2#      | CD/DAT3 信号                            |
| 3#      | CMD 数据输入                              |
| 4#      | VDD 电压/电                              |
| 5#      | CLK 时钟                                |
| 6#      | VSS 接地                                |
| 7#      | DATO 信号                               |
| 8#      | DAT1 信号                               |
| CD      | 侦测P                                   |
| P9      | V <sub>DD2</sub> SUPPLY VOLTAGE(L.SV) |
| P10     | V <sub>SS</sub> SUPPLY VOLTAGE GROUND |
| P11     | D0+ UHS-I1 D0+                        |
| P12     | D0- UHS-I1 D0-                        |
| P13     | V <sub>SS</sub> SUPPLY VOLTAGE GROUND |
| P14     | D1- UHS-I1 D1-                        |
| P15     | D1+ UHS-I1 D1+                        |
| P16     | V <sub>SS</sub> SUPPLY VOLTAGE GROUND |
| P17     | SWIO Single Wire Protocol Interface   |

**Specification**  
 Insulator: High Temperature Thermoplastic,  
 UL 94V-0, COLOR"BLACK LCP  
 (塑胶: 黑色LCP, 防火等级UL 94V-0)  
 SHELL: SUS301  
 Contact: Copper Alloy (磷铜C5210)  
 弹簧: 琴钢丝  
 拉杆: SUS301

**PLATING:**  
 Contact: All Ni50u, contact area 1u Au, Pad 0.8u Au  
 (接触端子电镀: 全部镀底50U, 接触区域1U金, 焊脚处0.8U金最小)  
 Shell: All 50u Ni, Pad 0.8u Au  
 (外壳电镀: 镀底50U, 焊接处0.8U金)

**Electrical:**  
 Current Rating :0.5amps max(额定电流:0.5A最大)  
 Voltage Rating :5V AC/DC(额定电压:5V AC/DC)  
 Ambient Temperature Range :-20° C+60° C(工作温度:-20度到+60度)  
 Storage Temperature Range :-40° C+70° C(工作环境:-20度到+80度)  
 Ambient Humidity Range :95% R.H. Max. (上锡效果: 95%以上)  
 Contact Resistance:100Ωmax. (端子接触电阻: 100Ω最大)  
 Insulation Resistance:1000Ωmin./500VDC(绝缘阻抗: 100兆欧最小)  
 Mating Cycles:3,000 Insertions (寿命: 3000次)  
 产品耐温温度: 260° C

**深圳市华宇创精密电子有限公司**

|  |                           |                             |   |
|--|---------------------------|-----------------------------|---|
| <b>TOLERANCE:</b><br>X.X ±0.30<br>X.XX ±0.25<br>X.XXX ±0.15<br>X' ±2' X.X' ±0.5' | <b>DRAWN BY :</b><br>陈一鸣  | <b>DATE :</b><br>2014-02-23 | <b>PART NAME:</b><br>TF PUSH 4.0卡座 1.5H |
|  | <b>CHECKED BY:</b><br>马跃  | <b>DATE :</b><br>2014-02-23 | <b>PART NO.</b><br>HYCW126-TF18-150B    |
| <b>UNIT: mm [inch]</b><br><b>SCALE:1:1 SIZE: A4</b>                              | <b>APPROVED BY:</b><br>邱敏 | <b>DATE :</b><br>2014-02-23 | <b>DRAW NO:</b><br>HYC-2106041020       |
|  |                           |                             | <b>SHEET NO.</b><br>1 OF 1              |

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